The 7th International Symposium on UbiCom Frontiers Innovative Research, Systems and Technologies (UFirst2015)

In conjunction with UIC 2015, ATC 2015, ScalCom 2015, CBDCom 2015, IoP 2015

WELCOME

UFirst 2015 covers novel theories, designs, and applications on Ubiquitous and Intelligent Engineering. Papers of high quality in the following areas are invited:

- Ubiquitous Computing Models, Theorems, Systems and Applications
- Smart Objects, Environments and Systems
- Service Computing Modeling, Management and Applications
- Mobile/Ubiquitous/Pervasive/Trust Computing
- Cloud/Utility/Web/Services Computing and Big Data
- Social Computing/Wearable Technology/Brain Informatics

IMPORTANT DATES

Invited Papers:	Invited by Congress
Open Call Submission Deadline:	May 15, 2015
Authors Notification:	May 20, 2015
Registration Deadline/Camera-ready (for Authors):	June 5, 2015
Conference Date:	August 10-14, 2015

PAPER SUBMISSION GUIDELINE

For Invited Papers

Invited authors do not need submit papers to easychair system for reviewing, but should submit a paper to IEEE CS for publication in the proceeding. A full paper of at most 6 pages includes all figures, tables, and references. The authors should follow the author kit to be sent by the IEEE CS for the preparation of the final manuscript. The author registration date and the final manuscript due date are strict. Please do follow the announcement on the the 2015 Smart World Congress website.

> For Open Call Papers

Open Call Papers authors MUST submit papers to easychair system for reviewing firstly. Open Call Papers Authors should refer to the "Formatting and Publication Instructions", to prepare your paper and submit it to https://easychair.org/conferences/?conf=ufirst2015 for reviewing.

Accepted papers will be published in one IEEE workshop proceeding together with **UIC. ATC 2015** (**EI-Index**), published by IEEE Computer Society Press. At least one of the authors of each accepted paper should register as a full participant of the workshop to have the paper published in the proceeding.

Co-LOCATED ACTIVITY

- The Smart World Summit
- The Open Forum on Top 10 Challenges for Smart Worlds
- <u>IEEE Technical Activities Volunteer Training Workshop</u>

ORGANIZING COMMITTEE

General Co-Chairs:

- Didier El Baz, LAAS-CNRS, France
- Bin Guo, Northwestern Polytechnical Univ., China
- Lu Liu, Univ. of Derby, UK
- Weishan Zhang, China Univ. of Petroleum (East China), China
- ZhangBing Zhou, China Univ. of Geosciences (Beijing), China

Program Chairs:

- Rui Wang, Univ. of Science and Technology Beijing, China
- Xing Xie, Microsoft Research, China
- Yinglong Xia, IBM T.J. Watson Research Center, USA
- Bofeng Zhang, Shanghai Univ., China
- Jianxin Li, Beihang Univ., China

FURTHER INFORMATION

Please contact us via Email: wangrui [AT] ustb.edu.cn and cc: service4congress@163.com, or via Tel: +86-10-62333406.